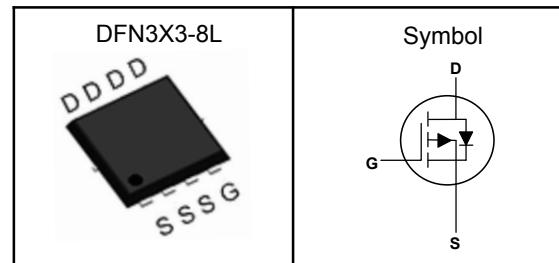


P-Channel Enhancement Mode MOSFET

Features

- Low R_{dson} for low conduction loss
- Reliable and Rugged
- ROHS Compliant & Halogen-Free

Pin Description



Applications

- Power Management in Desktop Computer
- DC/DC Converters

V_{DSS}	-20	V
$R_{DS(ON)-Typ}$	5.8	$\text{m}\Omega$
I_D	-55	A

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter		Rating	Unit
V_{DSS}	Drain-Source Voltage		-20	V
V_{GSS}	Gate-Source Voltage		± 12	V
T_J	Maximum Junction Temperature		-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55 to 150	$^\circ\text{C}$
$I_{DM}^{①}$	Pulse Drain Current Tested		-220	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	-55	A
I_D	Continuous Drain Current	$T_c=100^\circ\text{C}$	-35	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	42	W
E_{AS}	Avalanche Energy, Single pulse		43	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	3	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C .

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

P-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=-250\mu\text{A}$	-20	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	-1	μA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$	-0.4	---	-1.0	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 12\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS}(\text{ON})}$	Drain-Source On-state Resistance	$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-15\text{A}$	---	5.8	7.5	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}$, $I_{\text{D}}=-10\text{A}$	---	7.8	10	$\text{m}\Omega$
Dynamic Characteristics ^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-10\text{V}$, Freq.:1MHz	---	2840	---	pF
C_{oss}	Output Capacitance		---	372	---	
C_{rss}	Reverse Transfer Capacitance		---	311	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$, $V_{\text{DS}}=-10\text{V}$, $I_{\text{D}}=-13\text{A}$, $R_{\text{G}}=3\Omega$	---	13	---	nS
T_r	Turn-on Rise Time		---	105	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	145	---	
T_f	Turn-off Fall Time		---	150	---	
Q_g	Total Gate Charge	$V_{\text{GS}}=-4.5\text{V}$, $V_{\text{DS}}=-10\text{V}$, $I_{\text{D}}=-15\text{A}$	---	54	---	nC
Q_{gs}	Gate-Source Charge		---	7	---	
Q_{gd}	Gate-Drain Charge		---	14	---	
Source-Drain Characteristics						
I_s	Maximum Continuous Drain-Source Diode Forward Current	---	---	-55	A	
I_{sm}	Maximum Pulsed Drain-Source Diode Forward Current	---	---	-220	V	
V_{SD}	Diode Forward Voltage	$I_s=-10\text{A}$, $V_{\text{GS}}=0\text{V}$	---	---	-1.2	V
t_{rr}	Reverse Recovery Time	$I_F=-15\text{A}$, $dI_F/dt=100\text{A}/\mu\text{s}$	---	26	---	nS
Q_{rr}	Reverse Recovery Charge		---	15	---	nC

Note ④: Pulse test (pulse width 300us, duty cycle 2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

P-Channel Enhancement Mode MOSFET

Typical Characteristics

Figure 1: Output Characteristics

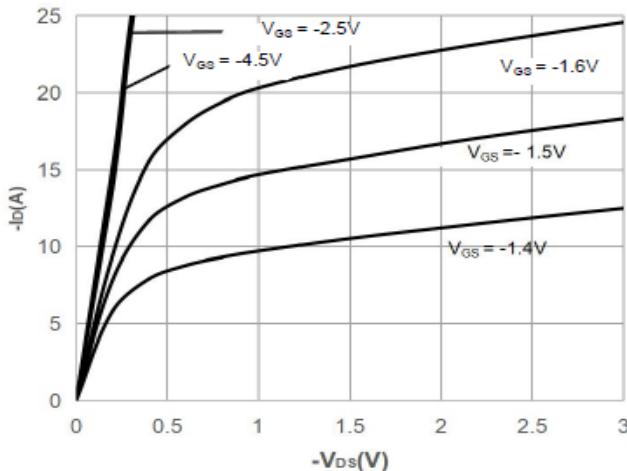


Figure 2: Typical Transfer Characteristics

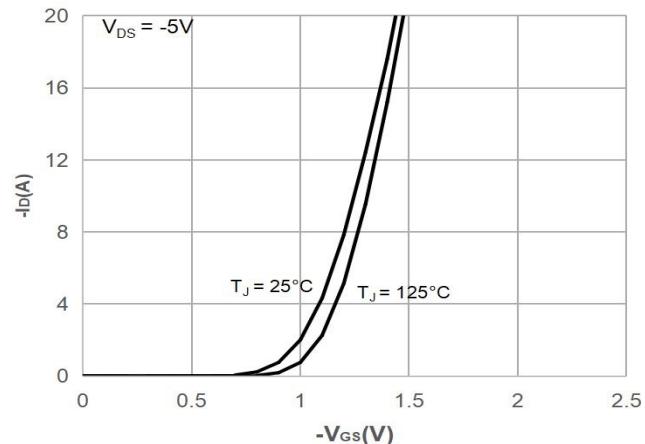


Figure 3: On-resistance vs. Drain Current

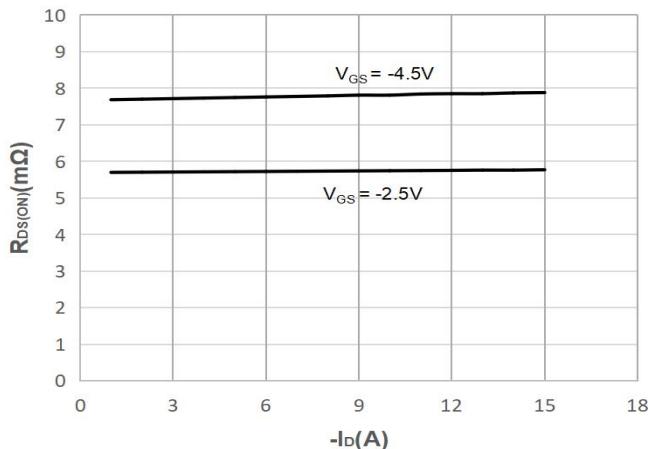


Figure 4: Body Diode Characteristics

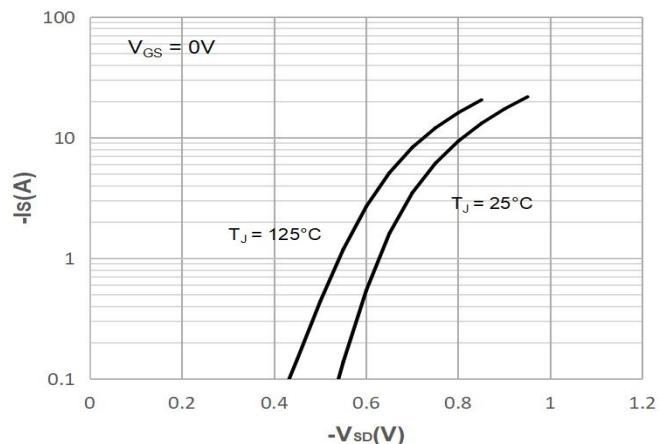


Figure 5: Normalized Breakdown voltage vs. Junction Temperature

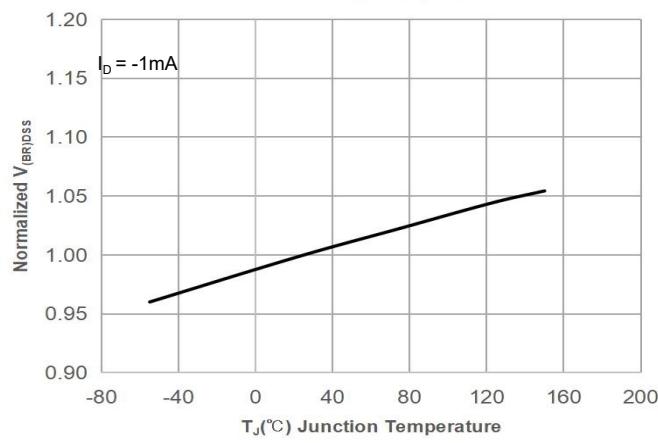
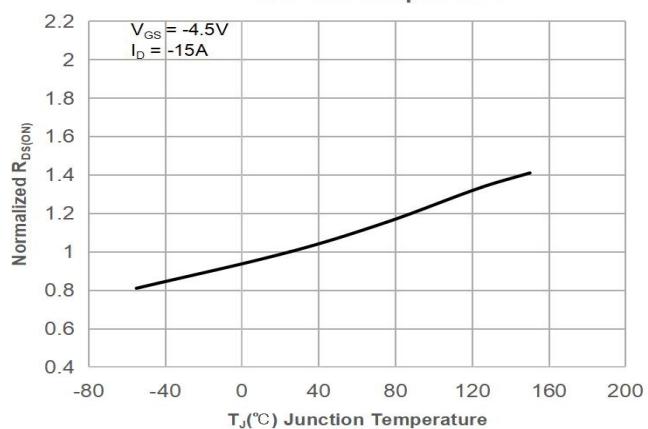


Figure 6: Normalized on Resistance vs. Junction Temperature



P-Channel Enhancement Mode MOSFET

Figure 7 : Gate Charge Characteristics

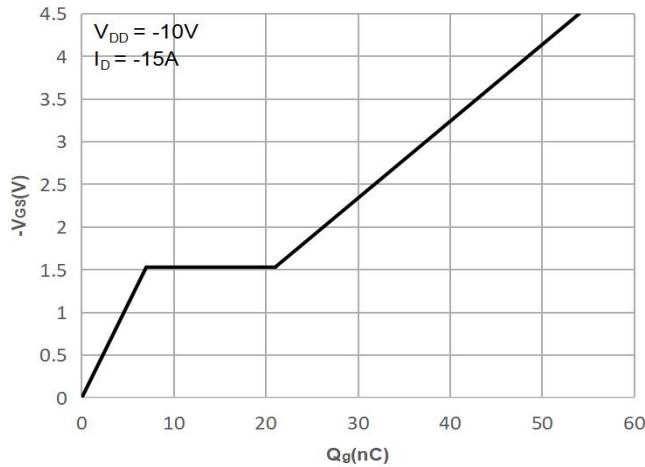


Figure 8 : Capacitance Characteristics

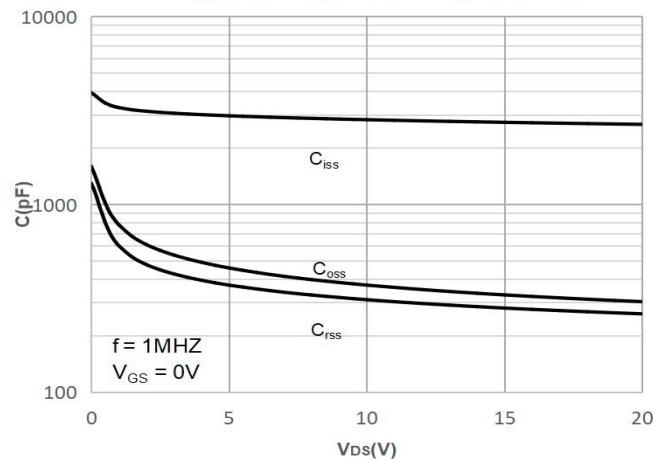


Figure 9: Maximum Safe Operating Area

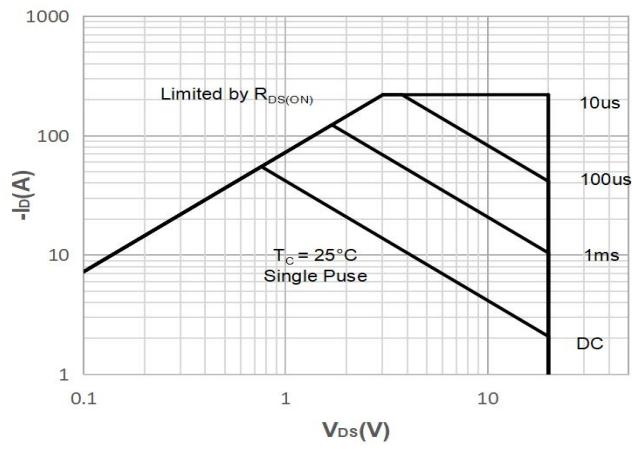


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

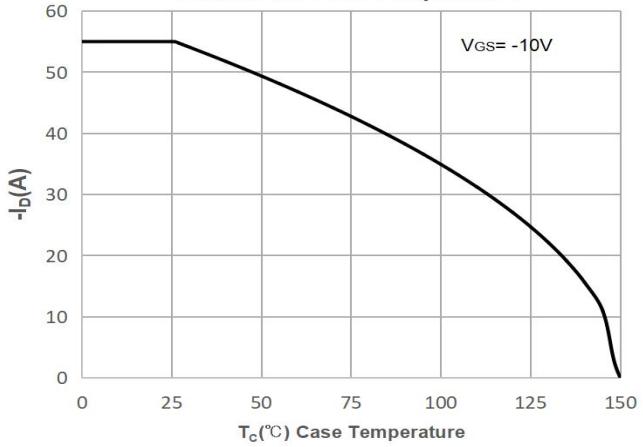


Figure 11: Normalized Maximum Transient Thermal Impedance

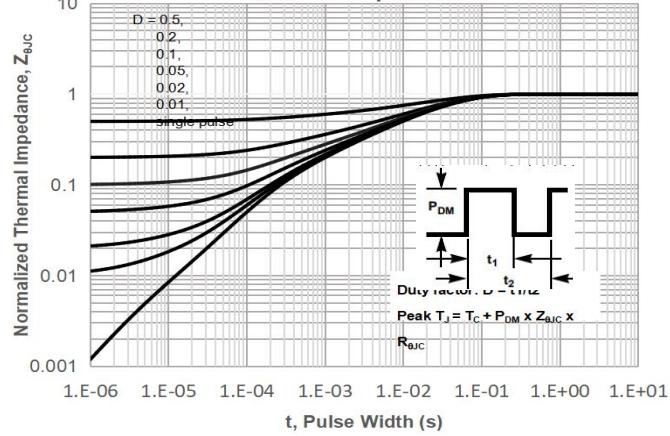
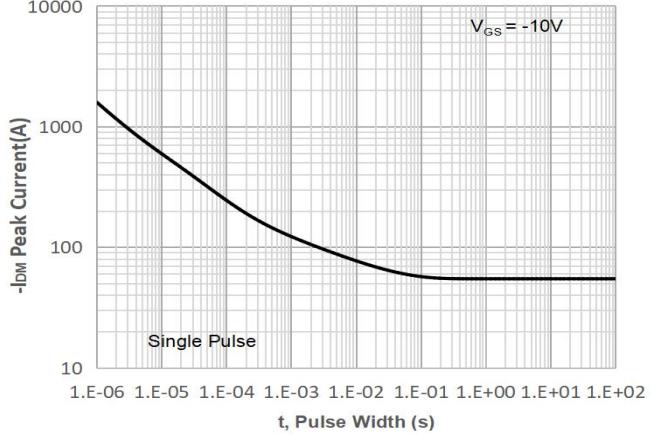
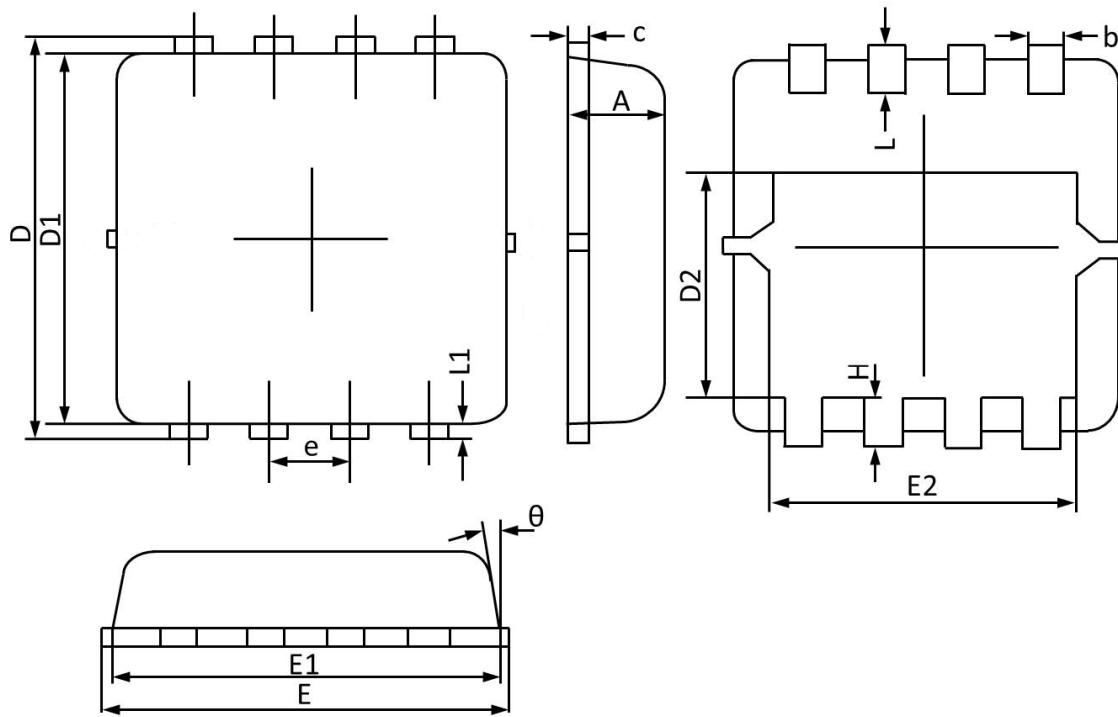


Figure 12: Peak Current Capacity



P-Channel Enhancement Mode MOSFET

DFN3X3-8L Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	0.70	0.75	0.85	E1	2.90	3.10	3.25
b	0.24	0.30	0.35	E2	2.35	2.50	2.60
c	0.10	0.17	0.25	e	0.65 BSC		
D	3.10	3.30	3.45	H	0.30	0.40	0.50
D1	2.90	3.05	3.20	L	0.30	0.40	0.50
D2	1.45	1.70	1.95	L1	--	0.13	--
E	3.05	3.25	3.40	θ	0°		14°